

SMG2314-VB Datasheet

N-Channel 20 V (D-S) MOSFET

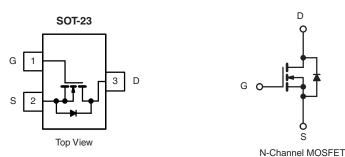
PRODUCT SUMMARY						
V _{DS} (V)	$\mathbf{R}_{DS(on)}(\Omega)$ $\mathbf{I}_{D}(A)^{e}$		Q _g (Typ.)			
	0.022 at V _{GS} = 4.5 V	6 ^a				
20	0.028 at V _{GS} = 2.5 V	= 2.5 V 6 ^a 8.8				
	0.039 at V _{GS} = 1.8 V	5.6				

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- DC/DC Converters
- Load Switch for Portable Applications



ABSOLUTE MAXIMUM RATIN	$H_{A} = 25 C,$				
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 12	- v	
	T _C = 25 °C		6 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		5.1		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _A = 25 °C	I _D	5 ^{b, c}		
	T _A = 70 °C		4 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	20		
Continuous Source-Drain Diode Current	T _C = 25 °C	L.	1.75		
Continuous Source-Drain Diode Current	T _A = 25 °C	IS	1.04 ^{b, c}		
	T _C = 25 °C		2.1		
Maximum Power Dissipation	T _C = 70 °C	P _D	1.3	w	
Maximum Fower Dissipation	T _A = 25 °C		1.25 ^{b, c}	~~~	
	T _A = 70 °C		0.8 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Tempera	ature)	Ŭ	260		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	80	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	60	- C/ W		

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 125 $^{\circ}\text{C/W}.$

e. Based on T_C = 25 °C.

HALOGEN

FREE

SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
		-	T	I	-		
	$V_{GS} = 0 V, I_D = 250 \mu A$	20			V		
	lp = 250 µA		25		mV/°C		
$\Delta V_{GS(th)}\!/T_J$			- 2.6				
V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.45		1.0	V		
I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			± 100	nA		
la ee	$V_{DS} = 20 V, V_{GS} = 0 V$			1	μA		
'DSS	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			10			
I _{D(on)}	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	20			Α		
	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$		0.022		Ω		
R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$		0.028				
	$V_{GS} = 1.8 \text{ V}, I_D = 4.3 \text{ A}$		0.039				
9 _{fs}	$V_{DS} = 10 \text{ V}, I_{D} = 5.0 \text{ A}$		24		S		
C _{iss}			865		pF		
	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		105				
Qg	$V_{DS} = 10 \text{ V}$. $V_{CS} = 5 \text{ V}$. $I_D = 5.0 \text{ A}$		-	18	nC		
				-			
Q _{as}	Vps = 10 V. Vcs = 4.5 V. lp = 5.0 A		1.1				
			0.7				
-	f = 1 MHz	0.5	2.4	4.8	Ω		
			8	16			
. ,	V_{DD} = 10 V, R_{L} = 2.2 Ω		17		- ns		
	$I_D \cong 4 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$						
. ,			-				
+ +				-			
	$V_{DD} = 10 \text{ V}, \text{ R}_1 = 2.2 \Omega$		-	-			
	$I_D \cong 4 \text{ A}, V_{\text{GEN}} = 5 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$						
	·						
· · ·		I			L		
T . T	T _C = 25 °C			1.75			
-	0				A		
	$I_{S} = 4 A, V_{CS} = 0 V$		0.75		v		
			-		ns		
					nC		
	$I_F = 4 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		7	10			
everse Recovery Fall Time t _a everse Recovery Rise Time t _b					ns		
	$\begin{tabular}{ c c c } \hline Symbol \\ \hline V_{DS} \\ \hline $\Delta V_{DS}/T_J$ \\ \hline $\Delta V_{GS}(th)/T_J$ \\ \hline $V_{GS}(th)$ \\ \hline I_{GSS} \\ \hline I_{DSS} \\ \hline I_{DSS} \\ \hline I_{DSS} \\ \hline $I_{D(n)}$ \\ \hline I_{GSS} \\ \hline $I_{D(n)}$ \\ \hline I_{Ciss} \\ \hline C_{iss} \\ \hline$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS(th)}/T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{GS}(th) & V_{DS} = 0 \ V, \ V_{GS} = \pm 8 \ V \\ \hline V_{DS} = 0 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ T_J = 70 \ ^{\circ}C \\ \hline I_{D}(on) & V_{DS} \le 5 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 4.5 \ V \\ \hline V_{DS} = 10 \ V, \ V_{GS} = 1.8 \ V, \ I_D = 5.0 \ A \\ \hline V_{DS} = 10 \ V, \ V_{GS} = 5 \ V, \ I_D = 5.0 \ A \\ \hline \hline V_{DS} = 10 \ V, \ V_{GS} = 5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{DS} = 10 \ V, \ V_{GS} = 5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{D} = 4 \ A, \ V_{GEN} = 4.5 \ V, \ I_D = 5.0 \ A \\ \hline \hline U_{D} = 4 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline U_{D} = 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline U_{D} = 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline U_{D} = 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline U_{D} = 4 \ A, \ V_{GEN} = 5 \ V, \ R_g = 1 \ \Omega \\ \hline \hline V_{SD} \ I_S = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline I_{T} \ I_{T} \ I_{T} \ I_{T} \ I_{T} = 4 \ A, \ U_{ID} = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline V_{SD} \ I_{S} = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline \hline V_{SD} \ I_{S} = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline \hline \hline V_{SD} \ I_{S} = 4 \ A, \ V_{GS} = 0 \ V \\ \hline \hline \hline \hline \hline \hline \hline V_{SD} \ I_{S} = 4 \ A, \ U_{S} = 0 \ V \\ \hline \hline \hline \hline \hline \hline \hline \hline V_{SD} \ I_{S} = 4 \ A, \ U_{S} = 0 \ V \ \hline \hline$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & 20 \\ \hline \Delta V_{DS}/T_J & I_D = 250 \ \mu A & 0.45 \\ \hline I_D = 250 \ \mu A & 0.45 \\ \hline V_{GS}(th) & V_{DS} = V_{GS} \ . I_D = 250 \ \mu A & 0.45 \\ \hline I_{GSS} & V_{DS} = 0 V, V_{GS} = 4.8 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V, V_{GS} = 0 \ V & V_{DS} = 20 \ V & V_{DS} = 10 \ V & V_{DS} = 10 \ V & V_{DS} = 10 \ V & V_{DS} = 5 \ V & I_D = 5.0 \ A \ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	$\begin{tabular}{ c c c c c } \hline Symbol & Test Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 20 & 25 \\ \hline & \Delta V_{GS}(th) & I_D = 250 \ \mu A & 0.45 & -2.6 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 0.45 & -2.6 \\ \hline V_{GS}(th) & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A & 0.45 & -2.6 \\ \hline V_{GS}(th) & V_{DS} = 0 \ V, \ V_{GS} = 4 \ V & 0.45 & -2.6 \\ \hline V_{DS} & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V & 0.5 & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V & 0.5 & -2.6 & -2.6 \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V & 0.20 & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V & 0.20 & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ V_{GS} = 0 \ V & 0.5 & -2.4 & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 10 \ V, \ V_{GS} = 5 \ V, \ I_D = 4.3 \ A & 0.028 & -2.6 & -2.6 \\ \hline V_{DS} & V_{DS} = 10 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 105 & -2.4 & -2.6 & -2.6 \\ \hline C_{rss} & V_{DS} = 10 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz & 105 & -2.4 & -2.6 & -2.6 \\ \hline C_{rss} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A & 1.1 & -2.6 & -2.6 & -2.6 \\ \hline C_{rss} & V_{DS} = 10 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 5.0 \ A & -2.4 & -2.6 $	$\begin{tabular}{ c c c c c } \hline \mathbf{Y}_{DS} & $V_{GS} = 0 $ V, $I_D = 250 μA & 20 & 25 & 1 & 25 & 1 & 1 & 1 & 1 & 25 & 1 $		

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Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



T_C = - 55 °C

1.2

1.5

20

T_C = 25 °C

0.6

0.9

10

Capacitance

25

50

75

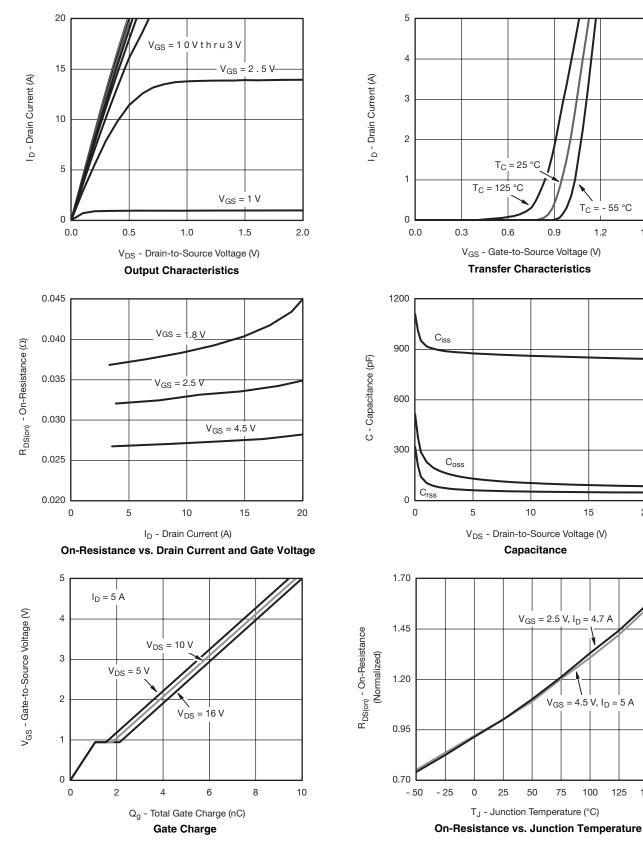
 $V_{GS} = 2.5 \text{ V}, I_D = 4.7 \text{ A}$

15

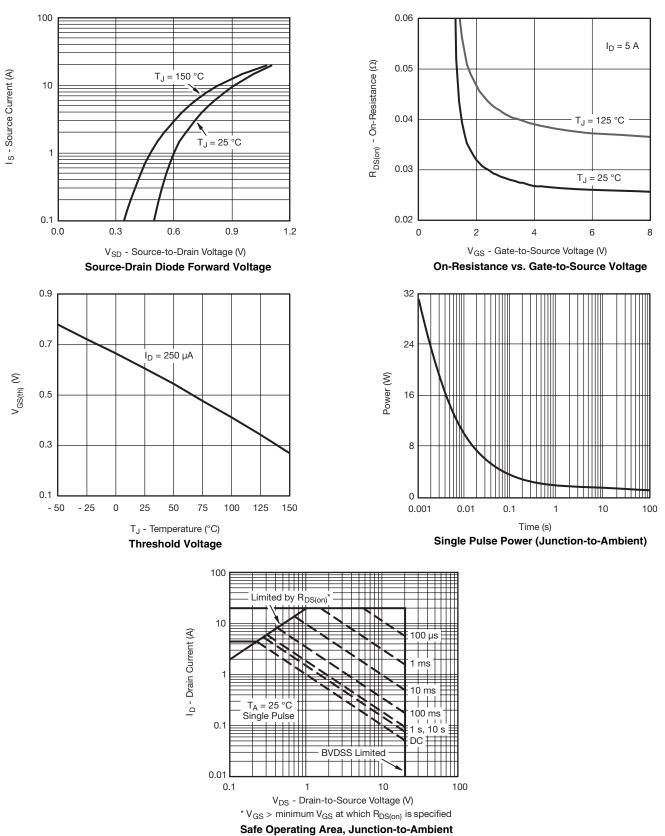
 $V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$

100

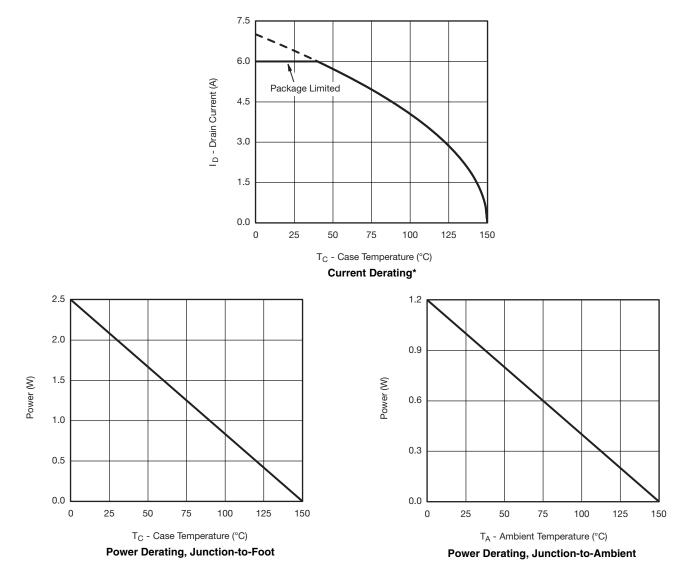
125 150





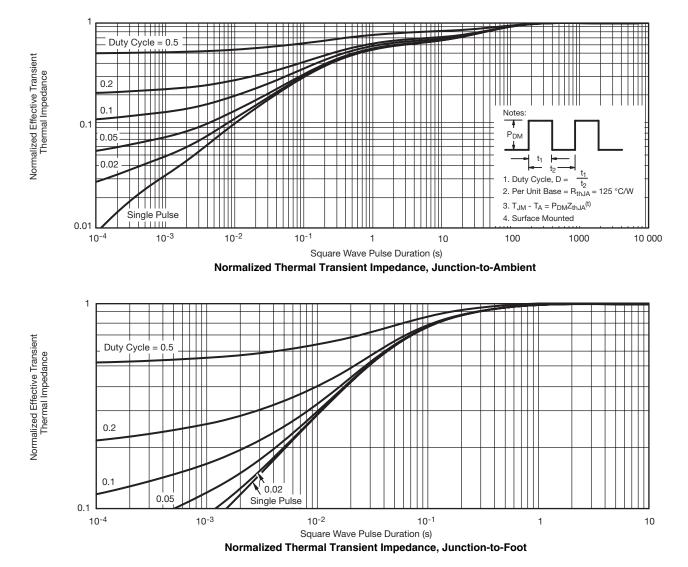






* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

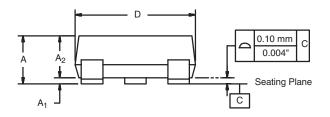






SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	IETERS	INCHES			
	Min	Мах	Min	Max		
Α	0.89	1.12	0.035	0.044		
A ₁	0.01	0.10	0.0004	0.004		
A ₂	0.88	1.02	0.0346	0.040		
b	0.35	0.50	0.014	0.020		
С	0.085	0.18	0.003	0.007		
D	2.80	3.04	0.110	0.120		
E	2.10	2.64	0.083	0.104		
E ₁	1.20	1.40	0.047	0.055		
е	0.95 BSC		0.0374 Ref			
e ₁	1.90 BSC		0.0748 Ref			
L	0.40	0.60	0.016	0.024		
L ₁	0.64 Ref		0.025 Ref			
S	0.50 Ref		0.020 Ref			
q	3°	8°	3°	8°		
ECN: S-03946-Rev. K, 09-Jul-01 DWG: 5479						



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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